E.G.S. PILLAY ENGINEERING COLLEGE

(Autonomous)

Approved by AICTE, New Delhi | Affiliated to Anna University, Chennai Accredited by NAAC with 'A'Grade |Accredited by NBA (CIVIL, CSE, ECE, EEE, IT, MECH)

 $NAGAPATTINAM-611\ 002$



B.E ELECTRONICS AND COMMUNICATION ENGINEERING

G	Correct Norma	T	т	р	C	Maximum Marks			Category
Course Code	Course Name	L	Т	Р	C	CA	ES	Total	
Theory Cou	rse								
1902EC701	1902EC701 Microwave Engineering 3 0 0 3 40 60 100								PCC
1902EC702	Optical Communication and Networks	3	0	0	3	40	60	100	PCC
1902EC703	Digital Image Processing	2	0	0	2	40	60	100	PCC
	HSS Elective II	3	0	0	3	40	60	100	HSSC
	Open Elective II	3	0	0	3	40	60	100	OEC
	Professional Elective - III	3	0	0	3	40	60	100	PEC
	Laborat	ory Co	urse						
1902EC751	Microwave and Optical Laboratory	0	0	2	1	50	50	100	PCC
1902EC752	Digital Image Processing Laboratory	0	0	2	1	50	50	100	PCC
1904EC753	Internship / In-plant Training	0	0	0	1	100	-	100	EEC
1904GE751	Comprehensive Viva	2	0	0	2	100	-	100	EEC
1904GE753	Mini Project	0	0	2	1	100	-	100	EEC
	Total	19	0	6	23	640	460	1100	

Third Year – Seventh Semester

Course	Course Name	т	т	р	С	Maximum Marks		larks
Code	Course Name	L	I	r	C	CA	ES	Total
	HSS E	lectiv	e - II					
1901HS001	Innovation & Entrepreneurship fundamentals	3	0	0	3	40	60	100
1901HS002	Intellectual Property Rights for Engineers	3	0	0	3	40	60	100
1901HS003	Startup Entrepreneurship	3	0	0	3	40	60	100
1901HS004	Business Model Innovation	3	0	0	3	40	60	100
	Open Elective –	- II (o	dd Se	meste	er)			
The course	es listed below are offered by the Department of	Electi	onics	and C	ommunic	cation Engir	neering for	students of

	other De	epartm	ents.					
1903EC017	Embedded System	3	0	0	3	40	60	100
1903EC007	Automotive Electronics	3	0	0	3	40	60	100
1903EC026	Mobile Communication	3	0	0	3	40	60	100
1903EC004	Display systems	3	0	0	3	40	60	100
1903EC027	Analog and Digital Communication	3	0	0	3	40	60	100
	Professiona	l Elect	tive -	III				
1903EC011	Micro Electronics	3	0	0	3	40	60	100
1903EC012		3	0	0	3	40	60	100
1903EC013	Network Security	3	0	0	3	40	60	100
	Soft Computing	3	0	0	3	40	60	100
1903EC015	Advanced Digital Signal Processing	3	0	0	3	40	60	100

1902EC701	_	MICROWAVE ENGINEERING	3	0	0	3
Course Objectives:						
course objectivest		ain knowledge about RF Electronics.				
		tudy about the various microwave components.				
		tudy about the various microwave signal generators and amplifie	rs.			
		ain knowledge about microwave integrated circuits.				
		tudy about the microwave measurement techniques.				
Unit I	INTRO	DUCTION TO RF ELECTRONICS			9 I	Hours
	-	n, units and Physical Constants, Microwave bands, RF behavio tors, Inductors and Capacitors. Voltage and Current in capacit			-	
Unit II	MICRO	DWAVE COMPONENTS			9 H	Iours
Couplers, Hybrid Te entrant Cavities, Wa	e Junctior	and their applications, Coaxial Line Components, Wave-guide , Magic Tee, Attenuators, Ferrite Devices, Isolators, Circulators, , Microwave Filters, Detectors, Mixers.			nators,	Re -
Unit III	MICRO	DWAVE SIGNAL GENERATORS AND AMPLIFIERS			9 H	Iours
	des, Resor	nant Cavity Devices, Reflex Klystron, Two -Cavity Klystron,	Multi -	- Cavi	ty Kly	stron,
		, Crossed Field Devices, Magnetrons, Semiconductor Devices, MPATT, TRAPATT Diodes.			BJTs, 1	
	n Diode, I	, Crossed Field Devices, Magnetrons, Semiconductor Devices,				
Tunnel Diodes, Gun Unit IV Materials, Substrate,	n Diode, I MICRO , Conducto	, Crossed Field Devices, Magnetrons, Semiconductor Devices, MPATT, TRAPATT Diodes.	Microv	wave 1	9 I	FETs, Hours
Tunnel Diodes, Gun Unit IV Materials, Substrate,	n Diode, I MICRO , Conducto Growth an	, Crossed Field Devices, Magnetrons, Semiconductor Devices, MPATT, TRAPATT Diodes. DWAVE INTEGRATED CIRCUITS or, Dielectric and Resistive Materials, MMIC Growth, Fabrication	Microv	wave 1	9 I Mosf	FETs, Hours
Tunnel Diodes, Gun Unit IV Materials, Substrate, Fabrication, NMOS Unit V	n Diode, I MICRO , Conducto Growth an MICRO	, Crossed Field Devices, Magnetrons, Semiconductor Devices, MPATT, TRAPATT Diodes. DWAVE INTEGRATED CIRCUITS or, Dielectric and Resistive Materials, MMIC Growth, Fabrication and CMOS Development, Thin Film Formation. DWAVE MEASUREMENTS	Microv	wave 1	9 I Mosf	FETs, <mark>Hours</mark> ET
Tunnel Diodes, Gun Unit IV Materials, Substrate, Fabrication, NMOS Unit V	n Diode, I MICRO , Conducto Growth an MICRO	, Crossed Field Devices, Magnetrons, Semiconductor Devices, MPATT, TRAPATT Diodes. DWAVE INTEGRATED CIRCUITS or, Dielectric and Resistive Materials, MMIC Growth, Fabrication and CMOS Development, Thin Film Formation.	Microv	wave 1	9 I MOSF 9 I	FETs, <mark>Hours</mark> ET
Tunnel Diodes, Gun Unit IV Materials, Substrate, Fabrication, NMOS Unit V VSWR, Frequency, O	n Diode, I MICRO , Conducto Growth an MICRO	, Crossed Field Devices, Magnetrons, Semiconductor Devices, MPATT, TRAPATT Diodes. DWAVE INTEGRATED CIRCUITS or, Dielectric and Resistive Materials, MMIC Growth, Fabrication ad CMOS Development, Thin Film Formation. DWAVE MEASUREMENTS velength, Coupling and Directivity measurements	Microv	wave 1	9 I MOSF 9 I	FETs, Hours ET Hours
Tunnel Diodes, Gun Unit IV Materials, Substrate, Fabrication, NMOS Unit V	n Diode, I MICRO , Conducto Growth an MICRO Guide Wa	, Crossed Field Devices, Magnetrons, Semiconductor Devices, MPATT, TRAPATT Diodes. DWAVE INTEGRATED CIRCUITS or, Dielectric and Resistive Materials, MMIC Growth, Fabrication and CMOS Development, Thin Film Formation. DWAVE MEASUREMENTS velength, Coupling and Directivity measurements Total:	Microv	wave 1	9 I MOSF 9 I	FETs, Hours ET Hours
Tunnel Diodes, Gun Unit IV Materials, Substrate, Fabrication, NMOS Unit V VSWR, Frequency, 0	n Diode, I MICRO , Conducto Growth an MICRO Guide Wa	, Crossed Field Devices, Magnetrons, Semiconductor Devices, MPATT, TRAPATT Diodes. DWAVE INTEGRATED CIRCUITS or, Dielectric and Resistive Materials, MMIC Growth, Fabrication ad CMOS Development, Thin Film Formation. DWAVE MEASUREMENTS velength, Coupling and Directivity measurements	Microv	wave 1	9 I MOSF 9 I	FETs, Hours ET Hours
Tunnel Diodes, Gun Unit IV Materials, Substrate, Fabrication, NMOS Unit V VSWR, Frequency, O Further Reading:	n Diode, I MICRO , Conducto Growth an MICRO Guide Wa 1.Recen	, Crossed Field Devices, Magnetrons, Semiconductor Devices, MPATT, TRAPATT Diodes. DWAVE INTEGRATED CIRCUITS or, Dielectric and Resistive Materials, MMIC Growth, Fabrication ad CMOS Development, Thin Film Formation. DWAVE MEASUREMENTS velength, Coupling and Directivity measurements Total: nt trends in Microwave application.	Microv	wave 1	9 I MOSF 9 I	FETs, Hours ET Hours
Tunnel Diodes, Gun Unit IV Materials, Substrate, Fabrication, NMOS Unit V VSWR, Frequency, O Further Reading:	n Diode, I MICRO Conducto Growth an MICRO Guide Wa 1.Recent	, Crossed Field Devices, Magnetrons, Semiconductor Devices, MPATT, TRAPATT Diodes. DWAVE INTEGRATED CIRCUITS or, Dielectric and Resistive Materials, MMIC Growth, Fabrication of CMOS Development, Thin Film Formation. DWAVE MEASUREMENTS velength, Coupling and Directivity measurements Total: nt trends in Microwave application. mpletion of the course, Student will be able to	Microv n Techn	iques,	9 H MOSF 9 H 45 I	FETs, Hours ET Hours
Tunnel Diodes, Gun Unit IV Materials, Substrate, Fabrication, NMOS Unit V VSWR, Frequency, O Further Reading:	n Diode, I MICRO Conducto Growth an MICRO Guide Wa 1.Recent After co 1.Expla	, Crossed Field Devices, Magnetrons, Semiconductor Devices, MPATT, TRAPATT Diodes. DWAVE INTEGRATED CIRCUITS or, Dielectric and Resistive Materials, MMIC Growth, Fabrication of CMOS Development, Thin Film Formation. DWAVE MEASUREMENTS velength, Coupling and Directivity measurements Total: nt trends in Microwave application. mpletion of the course, Student will be able to in about electromagnetic spectrum and passive components in Mi	Microv n Techn	iques,	9 H MOSF 9 H 45 I	FETs, Hours ET Hours
Tunnel Diodes, Gun Unit IV Materials, Substrate, Fabrication, NMOS Unit V VSWR, Frequency, O Further Reading:	n Diode, I MICRO Conducto Growth an MICRO Guide Wa 1.Recent After co 1.Expla 2.Identi	, Crossed Field Devices, Magnetrons, Semiconductor Devices, MPATT, TRAPATT Diodes. DWAVE INTEGRATED CIRCUITS or, Dielectric and Resistive Materials, MMIC Growth, Fabrication ad CMOS Development, Thin Film Formation. DWAVE MEASUREMENTS velength, Coupling and Directivity measurements Total: nt trends in Microwave application. mpletion of the course, Student will be able to in about electromagnetic spectrum and passive components in Mi fy the component for microwave application.	Microv n Techn	iques,	9 H MOSF 9 H 45 I	FETs, Hours ET Hours
Tunnel Diodes, Gun Unit IV Materials, Substrate, Fabrication, NMOS Unit V VSWR, Frequency, O Further Reading:	n Diode, I MICRO Conducto Growth an MICRO Guide Wa 1.Recent 1.Expla 2.Identi 3.Discu	, Crossed Field Devices, Magnetrons, Semiconductor Devices, MPATT, TRAPATT Diodes. DWAVE INTEGRATED CIRCUITS or, Dielectric and Resistive Materials, MMIC Growth, Fabrication ad CMOS Development, Thin Film Formation. DWAVE MEASUREMENTS velength, Coupling and Directivity measurements Total: nt trends in Microwave application. mpletion of the course, Student will be able to in about electromagnetic spectrum and passive components in Mi fy the component for microwave application. ss signal generator and amplifiers.	Microv n Techn	iques,	9 H MOSF 9 H 45 I	FETs, Hours ET Hours
Tunnel Diodes, Gun Unit IV Materials, Substrate, Fabrication, NMOS Unit V VSWR, Frequency, O Further Reading:	n Diode, I MICRO Growth an MICRO Guide Wa 1.Recent 1.Recent After co 1.Expla 2.Identi 3.Discu 4. Illust	, Crossed Field Devices, Magnetrons, Semiconductor Devices, MPATT, TRAPATT Diodes. DWAVE INTEGRATED CIRCUITS or, Dielectric and Resistive Materials, MMIC Growth, Fabrication of CMOS Development, Thin Film Formation. DWAVE MEASUREMENTS velength, Coupling and Directivity measurements Total: nt trends in Microwave application. mpletion of the course, Student will be able to in about electromagnetic spectrum and passive components in Mi fy the component for microwave application. ss signal generator and amplifiers. rate the concept of microwave integrated circuits.	Microv n Techn crowav	iques,	9 H MOSF 9 H 45 I	FETs, Hours ET Hours
Tunnel Diodes, Gun Unit IV Materials, Substrate, Fabrication, NMOS Unit V VSWR, Frequency, O Further Reading:	n Diode, I MICRO Growth an MICRO Guide Wa 1.Recent 1.Recent After co 1.Expla 2.Identi 3.Discu 4. Illust	, Crossed Field Devices, Magnetrons, Semiconductor Devices, MPATT, TRAPATT Diodes. DWAVE INTEGRATED CIRCUITS or, Dielectric and Resistive Materials, MMIC Growth, Fabrication ad CMOS Development, Thin Film Formation. DWAVE MEASUREMENTS velength, Coupling and Directivity measurements Total: nt trends in Microwave application. mpletion of the course, Student will be able to in about electromagnetic spectrum and passive components in Mi fy the component for microwave application. ss signal generator and amplifiers.	Microv n Techn crowav	iques,	9 H MOSF 9 H 45 I	FETs, Hours ET Hours
Tunnel Diodes, Gun Unit IV Materials, Substrate, Fabrication, NMOS Unit V VSWR, Frequency, Further Reading: Course Outcomes: References:	n Diode, I MICRO Conducto Growth an MICRO Guide Wa I.Recen I.Expla 2.Identi 3.Discu 4. Illust 5.Exper g, Pavel B	, Crossed Field Devices, Magnetrons, Semiconductor Devices, MPATT, TRAPATT Diodes. DWAVE INTEGRATED CIRCUITS or, Dielectric and Resistive Materials, MMIC Growth, Fabrication of CMOS Development, Thin Film Formation. DWAVE MEASUREMENTS velength, Coupling and Directivity measurements Total: nt trends in Microwave application. mpletion of the course, Student will be able to in about electromagnetic spectrum and passive components in Mi fy the component for microwave application. ss signal generator and amplifiers. rate the concept of microwave integrated circuits.	Microv n Techn	e field	9 H MOSF 9 H 45 I	FETs, Hours ET Hours
Tunnel Diodes, Gun Unit IV Materials, Substrate, Fabrication, NMOS Unit V VSWR, Frequency, G Further Reading: Course Outcomes: I. Reinhold Ludwing Publication, New De	n Diode, I MICRO Growth an MICRO Guide Wa I.Recen I.Expla 2.Identi 3.Discu 4. Illust 5.Exper g, Pavel B elhi 2001.	, Crossed Field Devices, Magnetrons, Semiconductor Devices, MPATT, TRAPATT Diodes. DWAVE INTEGRATED CIRCUITS or, Dielectric and Resistive Materials, MMIC Growth, Fabrication of CMOS Development, Thin Film Formation. DWAVE MEASUREMENTS velength, Coupling and Directivity measurements Total: Int trends in Microwave application. mpletion of the course, Student will be able to in about electromagnetic spectrum and passive components in Mi fy the component for microwave application. ss signal generator and amplifiers. rate the concept of microwave integrated circuits. iment with microwave devices to measure microwave parameter.	Microv n Techn	e field	9 H MOSF 9 H 45 I	FETs, Hours ET Hours
Tunnel Diodes, Gun Unit IV Materials, Substrate, Fabrication, NMOS Unit V VSWR, Frequency, Further Reading: Course Outcomes: References: 1. Reinhold Ludwing Publication, New De 2.Foundations For M	n Diode, I MICRO Growth an MICRO Guide Wa I.Recent After co I.Expla 2.Identi 3.Discu 4. Illust 5.Exper g, Pavel B elhi 2001.	, Crossed Field Devices, Magnetrons, Semiconductor Devices, MPATT, TRAPATT Diodes. DWAVE INTEGRATED CIRCUITS or, Dielectric and Resistive Materials, MMIC Growth, Fabrication of CMOS Development, Thin Film Formation. DWAVE MEASUREMENTS velength, Coupling and Directivity measurements Total: Int trends in Microwave application. mpletion of the course, Student will be able to in about electromagnetic spectrum and passive components in Mi fy the component for microwave application. ss signal generator and amplifiers. rate the concept of microwave integrated circuits. iment with microwave devices to measure microwave parameter. retchko, "RF Circuit design: Theory and applications", Pearson F	Microv n Techn	e field	9 H MOSF 9 H 45 I	FETs, Hours ET Hours
Tunnel Diodes, Gun Unit IV Materials, Substrate, Fabrication, NMOS Unit V VSWR, Frequency, Further Reading: Course Outcomes: I. Reinhold Ludwing Publication, New Dec 2.Foundations For M 3.Microwave Comm	n Diode, I MICRO Conducto Growth an MICRO Guide Wa I.Recen I.Recen After co I.Expla 2.Identi 3.Discu 4. Illust 5.Exper g, Pavel B elhi 2001. Iicrowave nunication	, Crossed Field Devices, Magnetrons, Semiconductor Devices, MPATT, TRAPATT Diodes. DWAVE INTEGRATED CIRCUITS or, Dielectric and Resistive Materials, MMIC Growth, Fabrication of CMOS Development, Thin Film Formation. DWAVE MEASUREMENTS velength, Coupling and Directivity measurements Total: Int trends in Microwave application. mpletion of the course, Student will be able to in about electromagnetic spectrum and passive components in Mi fy the component for microwave application. ss signal generator and amplifiers. rate the concept of microwave integrated circuits. iment with microwave devices to measure microwave parameter. retchko, "RF Circuit design: Theory and applications", Pearson E Engineering, R. R. Collin, McGraw Hill	Microv n Techn	e field	9 H MOSF 9 H 45 I	FETs, Hours ET Hours

1902EC702		OPTICAL COMMUNICATION AND NETWORKS	b L	Т	Р	С			
			3	0	0	3			
Course Objective									
	1. To learn structur	the basic elements of optical fiber transmission link, fiber r	nodes con	figura	tions a	and			
		rstand the different kind of losses, signal distortion in optica	al wave gu	ides a	nd oth	ier			
	signal	ation factors, Design optimization of SM fibers, PI profile of	nd out of		langt	h			
		ation factors. Design optimization of SM fibers, RI profile a about various Optical Sources and Detectors.	ind cut-on	wave	lengt	n.			
		bore the trends of optical fiber measurement systems.							
		the idea of optical fiber networks algorithm such as SON	ET/SDH a	nd op	ical (DMA			
Unit I	INTROD	UCTION TO OPTICAL FIBERS			9 Ho	urs			
Evolution of fiber optic system- Element of an Optical Fiber Transmission link Ray theory transmission- Total internal reflection-Acceptance angle –Numerical aperture – Skew rays – Electromagnetic mode theory of optical propagation –EM waves – modes in Planar guide – phase and group velocity – cylindrical fibers –SM fibers- Graded Index fiber structure.									
Unit II		DEGRADATION OPTICAL FIBERS			9 Ho				
Optical Wave g Dispersion, Signal	uides-Inforn distortion in ling -Optica	s, Scattering losses, Bending Losses, Core and Cladding los nation Capacity determination -Group Delay-Materia of SM fibers-Polarization Mode dispersion, Intermodal disper l fiber connectors, Fiber alignment and Joint Losses – Fiber Fiber Couplers	ul Disper ersion- Pu	sion, lse Br	Wav Daden	e guide ing in GI			
Unit III	SOURCI	ES AND DETECTORS			9 Ho	urs			
internal - quantum efficiency -Resona Optical Detectors:	Optical sources: Light Emitting Diodes - LED structures - surface and edge emitters, mono and hetero structures - internal - quantum efficiency, lasers Diodes-Modes and Threshold condition -Rate equations -External Quantum efficiency -Resonant frequencies- injection laser diode structures. Optical Detectors: PIN Photo detectors, Avalanche photo diodes, construction, characteristics and properties, Comparison of performance, Photo detector noise –Noise sources, Signal to Noise ratio, Detector response time.								
Unit IV		OPTIC RECEIVER AND MEASUREMENTS			9 Ho				
Quantum limit. Fi measurements – Fi diameter measurem	iber Attenua iber cut- off nents.	n, Pre amplifiers, Error sources – Receiver Configuration– ation measurements- Dispersion measurements – Fiber R Wave length Measurements – Fiber Numerical Aperture M	Refractive	index nts – F	profi iber				
Unit V		L NETWORKS AND SYSTEM TRANSMISSION			9 Ho				
linear effects on N	etwork perf ples of WD	DH – Broadcast – and –select WDM Networks –Wavelength ormance –-Link Power budget -Rise time budget- Noise E DM Performance of WDM + EDFA system – Solitons –	ffects on S Optical C	System	Perf – U	ormance- ltra High			
			Total:		45	Hours			
Further Reading:		asian Optimization of CM fibers DI profile and out off your	al an ath						
		esign Optimization of SM fibers-RI profile and cut-off wave ber amplifiers- Power Launching and coupling, Lencing sch							
Course Outcomes		ber ampriners- i ower Launening and coupling, Lenellig Sel	ientes						
		pletion of the course, Student will be able to							
		s the various optical fiber modes, configurations.							
		strate various signal degradation factors associated with op	tical fiber.						
		y various optical sources and optical detectors and their use		ical co	mmu	nication			
	system.								
	-	various Fiber Optic measurements.							
Defe	5. Calcula	ate the digital transmission and its associated parameters on	system pe	rform	ance.				
References:	ntigel El-	Communication" Ma Crow IIII Internetics -1 4th E 1'd	2010						
	1	Communication" Mc Graw -Hill International, 4th Edition.							
	-	ber Communication", Second Edition, Pearson Education, 2 Sasaki "Optical Networks", Morgan Kaufmann, 2009	2007.						
		cation, Principles and Practice", Prentice Hall of India, 3rd	Edition ?	008					
-		cation System", Prentice Hall of India, 2001.							

1902EC703		DIGITAL IMAGE PROCESSING	L	Т	Р	С
			3	0	0	3
Course Objectiv	ves:				1	
	1. To m	ake the students to understand the digital image fundamental	s.			
	2. To st	tudy the digital image using different transforms.				
	3. To a	cquire the basic knowledge in filters, image enhancement, im	age re	estora	tion a	nd
	com	pression techniques.				
Unit I		MAGE FUNDAMENTALS			9 Hou	
		essing systems, Elements of visual perception, Image samplin Image Transforms: Discrete Fourier transform, Cosine, Had				
Slant transform.	tween pixels.	inage Transforms. Discrete Fourier transform, Cosine, frac	aman	J, 11a	ai, w	aisii allu
Unit II	IMAGE AN	ALYSIS		•	9 Hou	rs
		tion and specification techniques, Basics of spatial filtering,	Smoo			
		I filters, Image smoothing and sharpening using frequency d			s.	
Unit III		GMENTATION			9 Hou	rs
Point, line and e	dge detection-l	Detection of isolated points, Line detection, Edge models, B	asic e	dged	etectio	on, Edge
		h. Thresholding-basic global thresholding, Otsu's method, M			riable	and
		ion-based segmentation-Region growing, Regionsplitting an	d mei			
Unit IV		STORATION AND RECOGNITION			9 Hou	
		n model, Noise models, Restoration-Spatial Filtering, C				
		her Filtering, Object recognition-Patterns and patternclasses	,Matc	hing-	Minin	num
		works-Background, Training by Back Propagation.) TT .	
Unit V		MPRESSION	1.		9 Hou	rs
		on methods-Huffman coding, Golomb coding, Arithmetic co ossless and Lossy predictive coding, Block transform coding,				
	<u> </u>		Tot	al:	4	5 Hours
Further Readin	g:					
		their properties, Homomorphic filtering, Morphological ima				
		Opening and closing, Segmentation using morphological wa	tershe	eds, A	pplica	ations of
	neural netwo	rks in image processing, Digital image watermarking.				
Course Outcom		the of the second Oterland will be the				
		tion of the course, Student will be able to				
		yze the image using image transforms.				
		elop a methodology for smoothening and sharpening of the ir nent the image using edge detection, thresholding and region		lann	roach	
		elop a method to restore the image and object recognition	-Dased	i appi	oach.	
		press the image using lossy and lossless compression technic	mes			
References:	5. Com	press are muge using lossy and lossiess compression welling	1403.			
	l Gonzalez and	E.Richard Woods, Digital Image Processing, Third Edition,	Pears	on Ec	lucatio	on
2008.						
		tals of Digital Image Processing, PHI, 2010.	<u>C11_2(</u>	10		
		rajan T Veerakumar, Digital Image Processing, Mc Graw-H	ш , 20	010		
4. K.Willia	im Pratt, Digita	ll Image Processing, John Wiley, 1997.				

5. M.A.Sid Ahmed, Image Processing Theory, Algorithm and Architectures, McGraw - Hill, 1995.

LABORATORY COURSE

1902EC751		Microwave and Optica	l Communication Lab	L	Т	Р	С
				0	0	4	2
Corres Objective							L
Course Objective		a datailad practical study o	n microwave signal and its co	omno	nonto		
		1 7	use in appropriate application		ments	•	
List of Experimen		the optical actives and to	use in appropriate appreciator				
MICROWAVE E		TS:					
1. Reflex Klystro							
2. Gunn Diode –							
		ve Length Measurement					
			fficient – S – parameter me	easu	reme	nt.	
5. Circulator – S							
6. Attenuation an							
		of E-Plane T, H-Plane T	and Magic T.				
8. Radiation Patt							
9. Antenna Gain							
OPTICAL EXP							
		and PIN Photo Diode.					
2. Mode Charact		and Bending Losses.					
4. Fiber Optic A		0					
-		nination for Fibers					
6. Attenuation M							
Additional Experi							
		f Manchester coding.					
List of Hardware							
1. Trainer kit for	carrying o	LED and PIN diode char	acteristics, Digital multi m	eter,	opti	cal p	ower
meter. – 2 Nos							
2. Trainer kit for	determini	the mode characteristics.	, losses in optical fiber 2	Nos.			
3. Trainer kit for	analyzing	nalog and Digital link per	rformance, 2 Mbps PRBS	Data	sour	ce, 10) MHz
		alog storage Oscilloscop				,	
4.Kit for measur	ing Numer	al aperture and Attenuation	on of fiber - 2 Nos.				
5.Glass and plast	tic fiber pat	h chords- 2 set.					
6. LEDs with ST	C / SC / E20	0 receptacles - 650 / 850	nm - 2 set.				
7.PiN PDs with	ST / SC / E	000 receptacles - 650 / 85	50 nm - 2 set.				
8. Microwave tes	st Bench at	band to determine Direc	tional coupler characteristic	cs	2 No	os.	
9.Microwave test	t Bench at	band and Antenna turn ta	able to measure Radiation	patte	rn of	Horr	1
antenna, 2 Horn	antennas	Nos.					
			R for Isolator and Circula	tor, V	/SW	R me	eter,
Isolator, Circula	tor, E Plan	Tee, H plane Tee 2 Nos	8.				
11.Microwave te - 2 Nos.	est Bench a	K band, Variable attenuat	or, Detector and 25 MHz A	Analo	og Os	cillo	scope.
Course Outcomes							
	-	tion of the course, Student w		4			
			to measure microwave parame		10		
References:	2. Analy	the performance of Fiber op	tic cable for analog and digital	signa	us.		
	wing, Pavel 1	etchko, "RF Circuit design: 7	Theory and applications", Pear	son E	ducat	ion A	sia
Publication, N			,				

2.Foundations for Microwave Engineering, R. R. Collin, McGraw Hill
3. Microwave Communications – Components and Circuits, E. Hund, McGrawHill.
4. Microwave Devices and Circuits, S. Y. Liao, PHI.
5.Microwave Engineering, R. Chatarjee, East – West Press Pvt. Ltd.

1902EC752		DIGIT	TAL IMAGE PROCESSING LAB	L	Т	Р	С
				0	0	4	2
Course Object							
			derstand the digital image fundamentals.				
			al image using different transforms.				
			d basic knowledge in filters, image enhancem	nent, i	mage	restor	ation
T' d of F		pression technique	ues.				
List of Experim		1.1			1.		
			evaluation of its histogram using histogram ne intensities (gray levels) of an image an				and
			canslation using Geometric transformation	18.			
3. Perform	n the Two-dim	nensional Four	ier transform operation in an image.				
4. Perform	n the Linear fil	ltering using co	onvolution in an image				
5. Image	Edge Detection	n Using Sobel	Filtering and Canny Filtering				
6. Perform	n the following	g operations in	an image.				
(a) erosion,			0				
(b) dil	ation,						
7. Perform	n the following	g operations in	an image.				
(a) opening,			0				
(b) closing,							
				Tot	al:	4	15 Hours
Additional Exp							
			tation algorithm development				
			patial and frequency domain				
			rations in analyzing image structures				
List of Hardwa	are/Software R	equired					
	1. MA'	TLAB with Sin	nulink and Image Processing Tool Box or I	Equiva	alent	Softv	vare in
		top systems -15	5 Nos				
Course Outcor							
			e, Student will be able to				
			amentals of Digital image processing and its a				
		0	hancement technique for the improvement of	picto	rial ir	ntorm	ation for
		in perception	fimage segmentation and compression				
			f image segmentation and compression etection and recognition technique learning				
References:	4. Denic	listrate object u	election and recognition technique learning				
	onzalez and F R	L Richard Woods	Digital Image Processing, Third Edition, Pear	rson F	duca	tion 2	008
			e Processing, PHI, 2010.		auca		
			, Digital Image Processing , Mc Graw-Hill, 2	2010			
			John Wiley, 1997.				
			, Algorithm and Architectures, McGraw - H	ill, 19	95.		

1904GE751 Comprehensive Viva L T P (TECHNICAL SEMINAR) 0 0 4								
	C 2							
BE (ECE)								
Course Objectives:								
1. To develop self-learning skills of utilizing various technical resources to make a								
technical presentation								
2. To promote the technical presentation and communication skills.								
3. To impart the knowledge on intonation, word and sentence stress for improving								
communicative competence, identifying and overcoming problem sounds.								
4. To promote the ability for Interacting and sharing attitude.								
5. To encourage the commitment-attitude to complete tasks								
GUIDELINES								
1. The students are expected to make two presentations on advanced topics (recent trends) related to IV year/semester subjects	VII							
2. A faculty guide is to be allotted and he / she will guide and monitor the progress of the student and main	tain							
attendance also								
3. It is mandatory that each student will interact individually a seminar/model on agreed topic and share t technical knowledge	heir							
4. Students are encouraged to use various teaching aids such as overhead Projectors. power point presentation	and							
demonstrative models								
5. During the final seminar sessions each student is expected to prepare and present a topic, for duration of not	less							
than 15 minutes. At the end of the semester student would have to submit the Report on the presentation								
TOTAL 30 HOURS								
Course Outcomes:								
After completion of the course, Student will be able to								
3. Identify and utilize various technical resources available from multiple field								
4. Improve the technical presentation and communication skills								
5. Improve communicative competence								
6. Interact and share their technical Knowledge								
7. Understand and adhere to deadlines and commitment to complete the assignments								
EVALUATION SCHEME								
Marks								
Distribution of Marks for Continuous Assessment								
Presentation I 40								
Report 10								
Presentation II 40								
Report 10								
Total 100 100								
Continuous Assessment (100 Marks)								
Continuous Assessment (100 Marks) References: https://spectrum.ieee.org/								

1904GE753		MINI PROJ	ЕСТ	L	Т	Р	С
	Į			0	0	2	1
Course Objectives:		The students should be made to:					
		1. To develop self-learning skills of	of utilizing various technical re	sourc	es to	make	
_		a technical presentation.2. To test technical presentation and	ad communication skills				
The starts	. 4 -						4
		(with team size no more than 4 stude: nt trends) related to Electronics and C					
		he / she will guide and monitor the pro					
		en course co coordinator will take ca					
		th as power point presentation and de					
		ess than three faculties (excluding cou					
		aken into consideration.					81,011
		ontinuous Assessment (100)					
	-	()					
Distribution of marks	s fo	or Continuous Assessment:					
ZEROTH REVIEW :		1	10 marks				
FIRST REVIEW:		2	20 marks				
SECOND REVIEW:		2	20 marks				
FINAL REVIEW/DEM	МС	: 3	30 marks				
REPORT:		2	20 marks				
Total Marks:		1	100				
				Tot	al:	301	Hours
Course Outcomes:							
	A	ter completion of the course, Student v	will be able to				
		1. Utilize various technical resourc	ces available from multiple fiel	ds.			
		2. Improve the technical presentati					
Γ		3. Connect different domains to ma					
		4. Maximize their technical knowledge	<u> </u>				
		5. Produce different assignments b	based on real time systems.				

HSS Elective II

1901HS001	Innovation & Entrepreneurship Fundamentals	L	Т	Р	С
DDEDEOLUSITE.					
PREREQUISITE:	ourse assumes no prior skill or background in design, art or en	nainaa	ring It	is one	to all
under	graduates and graduate students with an interest in learning ally recommended for those students planning social-venture entions	g desig	n think	ing, ar	d is
COURSE OBJEC					
	1. Cultivate the mindset and skills of successful entreprene	urs			
	2. Lead innovative teams				
	3. Develop and refine your strategy in today's fast-changin	g, dyna	amic m	arkets	
	4. Grow your customer base through inbound and outbound	d mark	eting		
Module I En	trepreneurship Basics			9 Ho	ours
	Basics – Skills, Mindset, Myth vs Fact, Entrepreneuri	al Lea	adershi		
	cal lessons in entrepreneurial leadership, innovation, teamy				
	Risk management. Business Opportunity Identification, Ide				
Entrepreneurs Stor					
	novation & Creativity			9 Ho	
• •	rrent Business Scenario, Innovation and Creativity- An I				
	ent, Types of Innovation, School of Innovation, Challeng ement, Idea Management System, Divergent V/s Convergent				-
and Entrepreneurs		1 11111KI	ing, De	sign 11	miking
	siness Models & Strategies for Innovation			9 Ho	ours
	Innovation Management, Idea Championship, Participation	for Inn	ovation		
for Innovation, Pr	oto typing to Incubation, What is a Business Model, Who				
	Blue Ocean Strategy-I, Blue Ocean Strategy-II				
	arketing & Sustainability of Innovation			9 Ho	
	novation, Technology Innovation Process, Technological				gement
	logical Innovation Management Strategies, Technology ntrepreneurship, Innovation Sustainable Conditions, Innova				
	nvolvement in sustainable development, Exploration of bu				
efficiency services		0111000		, 101 1	
Module V Ma	naging Innovation : IPR			9 Ho	ours
Management of Ir	novation, creation of IPR ,Management of Innovation, crea	tion of	IPR,	Types	of IPR,
	ights, Patents in India, Business Models and value proposition				
	edies, Incubators : Business vs Technology, Managing Inves	stor for	· Innov	ation,	Future
markets and Innov	ation needs for India.	r	ТОТАІ	• 15 1	
Course Outcomes:		. <u> </u>			IUUKS
	basics of Entrepreneurship & Innovation				
2. Analyze Le	adership Styles and compare them				
	siness models based on the requirement and justify with cases				
	method or mechanism for Innovation marketing and sustainabilit		ntation		
5. Develop a FURTHER READ	Business Model and Strategy framework and demonstrate throug	n prese	mation		
	8 Steps To Innovation : Going From Jugaad To Excellence-	- Book	by Risl	nikesha	T.
1.	Krishnan and Vinay Dabholkar	2000	5 1131		
2.	Innovation and Entrepreneurship Book by Peter Drucker				
3.	HBS series on Innovation and Entrepreneurship				
REFERENCES:					
1	Book by Eric Ries, 2013				
2. Zero to One Book	by Blake Masters and Peter Thiel, 2014				

3. Founders at Work: Stories of Startups' Early Days Book by Jessica Livingston, 2001

4. Crossing the Chasm Book by Geoffrey Moore, 1991

5. Hooked: How to Build Habit-Forming Products Book by Nir Eyal, 2013

6. Rework Book by David Heinemeier Hansson and Jason Fried, 2010

7. https://nptel.ac.in/courses/127/105/127105007/

1901HS002		INTELLECTUAL PROPERTY RIGHTS FOR	L	Т	Р	C
		ENGINEERS	2	0	0	2
			3	0	0	3
Course Objective	es:					
1. To know	about their r	ghts for the protection of their invention done in their proj	ect work.			
		ents processing system				
3. To be far	niliar with co	pyrights and IPR related issues.				
Unit I	INTRODU	CTION TO IPR			9	Hours
Basic types of p	property - T	angible and Intangible property - Movable Property a	nd Imm	ovable	Prop	erty -
Intellectual Prope of IPR.	erty – Inventi	on and Creativity - Innovation – Intellectual Property (IP) – Impor	tance	– Prot	tection
Unit II	CLASSIF	CATIONS OF IPR			9	Hours
		d related rights - Trade Marks and rights arising from				
Definitions – Ind International leve		ns and Integrated circuits – Protection of Geographical on Procedures.	Indicatior	is at r	nationa	l and
Unit III	INTERNA	TIONAL TREATIES ON IPR			91	Hours
		ng to Intellectual Property - TRIPS Agreement - Madrid				
		Berne convention-Patent cooperation treaty-Paris conve				
Unit IV		sion and Activities – History – General Agreement on Trac PR LEGISLATIONS	ie and Ta	riff (G		Hours
		1 Strategies – The Patent Act, 1970 – Inventions Non-	Datantah			
		r_{0} = monometric fractional				
		Present against unfair competition.				
Unit V		ECTRONICS AND INFORMATION TECHNOLOGY				Hours
		ion Technology -Case Studies on - Patents pertaining to				
		ts International scenario – Patent & Copyright Protection	n for soft	ware8	z Elec	tronic
inventions - IPR i	n Electronics	and Information Technology.			45 1	T
Funthan Dooding			otal:		45	Hours
Further Reading	;	1. New developments in trade mark law				
		2. Foundations of patent law				
Course Outcome	s:	r				
		letion of the course, Student will be able to				
	1. Ur	derstands the legal issues on Intellectual Property Rights				
	2. Ar	ability to register a trade mark, copyrights, patents				
	3. Pr	edict issues related to Intellectual property rights on tra-	ademarks	, cop	yrights	and
	pa	ents				
	4. Su	mmarize and evaluate trade secrets, unfair competition wh	ich is bei	ng ado	pted b	у
		ious firms.				
Defense	5. Di	stinguish between legal procedures for patents and copyrig	hts.			
References: 1. BARE A	CT Indian D	atent Act 1970 Acts & Rules, Universal Law Publishing C	O Dref I 4	4 204	7	
		ging Intellectual Property by (Prentice Hall of India Pvt.Lt		u., 20	07.	
		, —Intellectual Property Rights, Cengage Learning India		d 200)5	
2. 20001011		. — Intenectual Flobenty Rights a Cengage Leanning mina				
4. Stim,—In		pperty Copyrights, trademarks, and Patents, Cengage Learning India				

	2004.
5.	Prabuddha Ganguli, —Intellectual Property Rights, I, TMH, 2001.
6.	Lal, C.S, —Intellectual property handbook: copyright, designs, patent and trademarksl, Law Publishers
	Allahabad, 2000.

1901HS003	STARTUP ENTREPRENEURSHIP	L	Τ	P	Ε
PREREQUIS					
INEREQUI	The course assumes no prior skill or background in design, art, er	nain	oorii		r
	science It is open to all undergraduates and graduate students wit	-		-	
	learning Entrepreneurship, and is especially recommended for the				
	planning venture creation and other kinds of entrepreneurial interv			ints	
COURSE OB		vent	10115		
	1. Understand the terminology and conceptual of Entrepreneurshi	in <i>&</i>	Star	tuns	
	2. Understand real time problem solving methodologies with tool	<u> </u>	Sta	tups	
	3. Recognize the ethical and social dilemmas and obligations of the		rooti	00.0	
	design of solutions	ne p	Tacu	ce o.	-
	4. Diagnose common adoption barriers in individuals, groups and	dor	aoni	otio	10
			-		
	5. Develop a design theory from independent and qualitative observations	e ie	searc		IU
		aatt			
	6. Participate in and lead innovation in creative and collaborative		-		•
	7. Undertake complex and unstructured problem-solving unfamiliar domains	cn	allen	iges	11
Module I	Entrepreneurship & Startup Basics		5	5 Ho	ur
Entrepreneurs	hip basics - Skill Set, Mindset, Examples, Startup basics overview,	, Inc	lian	Star	ur
					~r
Ecosystem, Pi	coblems – Identification, Selection, Evaluation, Validation, Teaming	-			~r
Module II	Customer Discovery Process		7	7 Ho	ır
Module II Customer Dis discovery wit customer segr	Customer Discovery Process scovery Process, Opportunity Identification, Evaluating Opportunith h at least 15 interviews. Results presentation and hypothesis refinest ments of the business model canvas.	ties,	Cua t. Fo	stom ocus	ur er or
Module II Customer Dis discovery wit customer segr Module III	Customer Discovery Process scovery Process, Opportunity Identification, Evaluating Opportunity h at least 15 interviews. Results presentation and hypothesis refinements of the business model canvas. Ideation	ties, men	Cua t. Fo	stom ocus 5 Ho	ur er or
Module II Customer Dis discovery wit customer segr Module III Ideation – Bra	Customer Discovery Process scovery Process, Opportunity Identification, Evaluating Opportunity h at least 15 interviews. Results presentation and hypothesis refinesements of the business model canvas. Ideation instorming, Technology driven Ideation, Continued customer discover	ties, men	Cua t. Fo	stom ocus 5 Ho	ur er or
Module II Customer Dis discovery wit customer segr Module III Ideation – Bra to hypothesis.	Customer Discovery Process scovery Process, Opportunity Identification, Evaluating Opportunity h at least 15 interviews. Results presentation and hypothesis refinements of the business model canvas. Ideation	ties, men	Cur Cur t. Fo	stom ocus 5 Ho	er or ur es
Module II Customer Dis discovery wit customer segr Module III Ideation – Bra to hypothesis. Module IV Market Analy To Market Stra of business m	Customer Discovery Process scovery Process, Opportunity Identification, Evaluating Opportunity h at least 15 interviews. Results presentation and hypothesis refinements of the business model canvas. Ideation instorming, Technology driven Ideation, Continued customer discover Focus on value proposition of business model canvas. Market Analysis sis – Perform market research, Competitive advantage landscape, Marategies, Continued customer discovery and updates to hypothesis. Focusodel canvas.	ties, men ery a cket	Cu: t. Fo und u Size n ch	stom ocus 5 Ho pdat 6 Ho , Go anne	ur or ur es ur
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Module II Customer Dis discovery wit customer segr Module III Ideation – Bra to hypothesis. Module IV Market Analy To Market Stra of business mo Mid-te Module V	Customer Discovery Process scovery Process, Opportunity Identification, Evaluating Opportunity h at least 15 interviews. Results presentation and hypothesis refinements of the business model canvas. Ideation instorming, Technology driven Ideation, Continued customer discover Focus on value proposition of business model canvas. Market Analysis sis – Perform market research, Competitive advantage landscape, Marategies, Continued customer discovery and updates to hypothesis. Focus odel canvas. rm presentation on startup idea, refined hypothesis through custor Minimum Viable Product	ties, men ery a rket s on	Cu: Cu: t. Fo ind u Size n ch	stom ocus 5 Ho pdat 6 Ho anne cove 5 Ho	ur or ur es ur s
Module II Customer Dis discovery wit customer segr Module III Ideation – Bra to hypothesis. Module IV Market Analy To Market Stra of business mo Mid-te Module V Minimum Via	Customer Discovery Process scovery Process, Opportunity Identification, Evaluating Opportunity h at least 15 interviews. Results presentation and hypothesis refinements of the business model canvas. Ideation instorming, Technology driven Ideation, Continued customer discover Focus on value proposition of business model canvas. Market Analysis sis – Perform market research, Competitive advantage landscape, Marategies, Continued customer discovery and updates to hypothesis. Focusodel canvas. rm presentation on startup idea, refined hypothesis through custor Minimum Viable Product able Product/Validation: Product market fit, use customer discovery	ties, men ery a cket s on ome	Cua Cua t. Fo and u Size n ch r dis	stom ocus 5 Ho pdat 6 Ho , Go anne 5 Ho ing	ur er or es ur s
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Module II Customer Dis discovery wit customer segr Module III Ideation – Bra to hypothesis. Module IV Market Analy To Market Analy To Market Analy Market Analy Market Analy Market Analy Module IV Mid-te Module V Minimum Via MVP, Build I model canvas Module VI Business Mod	Customer Discovery Process scovery Process, Opportunity Identification, Evaluating Opportunity h at least 15 interviews. Results presentation and hypothesis refinements of the business model canvas. Ideation instorming, Technology driven Ideation, Continued customer discover Focus on value proposition of business model canvas. Market Analysis sis – Perform market research, Competitive advantage landscape, Marategies, Continued customer discovery and updates to hypothesis. Focus odel canvas. rm presentation on startup idea, refined hypothesis through custor able Product/Validation: Product market fit, use customer discovery Proof Of Concepts for specific customer use-cases. Focus on metric Business Models els/Metrics – Chosen business model for the venture, Focus on key	ties, men ery a cket s on ome	Cu: Cu: t. Fo ind u Size n ch r dis f b	stom ocus 5 Ho pdat 6 Ho anne 6 Ho ing usin	ur er or ur es ur s
Module II Customer Dis discovery wit customer segr Module III Ideation – Bra to hypothesis. Module IV Market Analy To Market Stra of business ma Mid-te Module V Minimum Via MVP, Build I model canvas. Module VI Business Mod resources/acti	Customer Discovery Process Scovery Process, Opportunity Identification, Evaluating Opportunity h at least 15 interviews. Results presentation and hypothesis refinements of the business model canvas. Ideation instorming, Technology driven Ideation, Continued customer discover Focus on value proposition of business model canvas. Market Analysis sis – Perform market research, Competitive advantage landscape, Marategies, Continued customer discovery and updates to hypothesis. Focus odel canvas. m presentation on startup idea, refined hypothesis through custor Minimum Viable Product Minimum Viable Product Business Models Business model canvas. Business Models els/Metrics – Chosen business model for the venture, Focus on key vities of business model canvas. Start customer validation phase.	ties, men ery a cket s on ome	Cu: Cu: t. Fo ind u Size n ch r dis f defin of b 7 H	stom ocus 5 Ho pdat 5 Ho , Go anne 5 Ho ing usin (our	ur er on ur es ur s
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Module II Customer Dis discovery wit customer segr Module III Ideation – Bra to hypothesis. Module IV Market Analy To Market Stra of business modil Mid-tee Module V Minimum Via MVP, Build I model canvas. Module VI Business Modil resources/actin Module VII Pivoting - Piv	Customer Discovery Process Scovery Process, Opportunity Identification, Evaluating Opportunity hat least 15 interviews. Results presentation and hypothesis refinements of the business model canvas. Ideation instorming, Technology driven Ideation, Continued customer discover Focus on value proposition of business model canvas. Market Analysis sis – Perform market research, Competitive advantage landscape, Marategies, Continued customer discovery and updates to hypothesis. Focu odel canvas. m presentation on startup idea, refined hypothesis through custor discovery Product ble Product/Validation: Product market fit, use customer discovery Proof Of Concepts for specific customer use-cases. Focus on metric Business Models els/Metrics – Chosen business model for the venture, Focus on key vities of business model canvas. Start customer validation phase. Pivoting ot product and business models based on customer discovery and val	ties, men ery a ket is of ome rics	Cua Cua t. Fo size n ch r diss r diss f defin of b 7 H 3 H ion,	stom ocus 5 Ho pdat 6 Ho anne 6 Ho ing usin Iour Cho	ur er on ur es ur s ry ur tho es s
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Module II Customer Dis discovery wit customer segr Module III Ideation – Bra to hypothesis. Module IV Market Analy To Market Analy To Market Stra of business mod Mid-te Module V Minimum Via MVP, Build I model canvas. Module VI Business Mod resources/acti Module VII Pivoting - Piv pivot directio customer valio	Customer Discovery Process scovery Process, Opportunity Identification, Evaluating Opportunity h at least 15 interviews. Results presentation and hypothesis refinements of the business model canvas. Ideation instorming, Technology driven Ideation, Continued customer discover Focus on value proposition of business model canvas. Market Analysis sis – Perform market research, Competitive advantage landscape, Marategies, Continued customer discovery and updates to hypothesis. Focu odel canvas. rm presentation on startup idea, refined hypothesis through custor able Product/Validation: Product market fit, use customer discovery Proof Of Concepts for specific customer use-cases. Focus on metric Business Models els/Metrics – Chosen business model for the venture, Focus on key vities of business model canvas. Start customer validation phase. Pivoting ot product and business models based on customer discovery and val n. Focus on cost structures and partners of business model canvas	ties, men ery a ket is or ome in o rics	Cua Cua t. Fo ind u Size n ch Size n ch c dis defin of b 7 H 3 H ion, ontin	stom ocus 5 Ho pdat 6 Ho , Go anne 5 Ho ing usin 10ur Choo ued	ur er on ur es ur s s s s s

	prototype refinemer	nts and plan.
Module VIII		4 Hours
IP/Legal: Impor	tance of IP, Protect IP, Licensing IP, IP based Entrepreneurship; Exar	nples,
Continued custo		-
Module IX	Capital	3 Hours
	requirement for the venture, Raising capital & increments, Continu idity/Exit: Liquidity events, Trade-offs	ed customer
	tions of startup idea, refined prototype, customer validation, and f	future plans
I		45 HOURS
Course Outcon		
	ntrepreneurship and Startup Basics	
	the methods and tools of Problem Solving in business context	
	tartup Idea Development Process and Methodologies through Real Proble	em
Solving		
4. Develop	Startup Prototype through Customer Validation and Business Models	
5. Explain l	Intellectual Property Rights and its importance in business context	
FURTHER RE	ADING:	
	1. The Startup Owner's Manual: The Step-By-Step Guide for Bu	uilding a
	Great Company by Steve Blank	
	2. Value Proposition Design: How to Create Products and Servi	ces
	Customers Want (Strategyzer) by Alexander Osterwalder	
	3. Business Model Generation: A Handbook for Visionaries, Ga	ame
	Changers, and Challengers by Alexander Osterwalder	
	4. The Four Steps to the Epiphany, Steven Blank	
REFERENCES		
	idence: Unleashing the Creative Potential Within Us All Book by Dav	id M.
Kelley and Tom		
	esign: How Design Thinking Transforms Organizations and Inspires In	novation
Book by Tim Br		
	ovation by Tom Kelly, 2011	
	ing for Strategic Innovation: What They Can't Teach You at Business Idris Mootee, 2013	Or Design
	f Everyday Things Book by Don Norman, 1988	
6. The Design T	hinking Playbook: Mindful Digital Transformation of Teams, Products	s, Services,
	Ecosystems Book by Michael Lewrick, 2017	
	c.in/courses/109104109/	

1901HS004	HS004 Business Model Innovation L T							
PREREQU	JISITE:							
	open to a	se assumes no prior skill or background in design, art, engin Il undergraduates and graduate students with an interest in le y recommended for those students planning social-venture ar	arning d	esign th	inking	, and is		
COURSE (
		erstand the Business Model Canvas						
	2. Mast	er the different types of Innovation						
	3. Desi	gn Innovative Business Models						
	4. Diffe	erentiate from Competition						
	5. Unde	erstand purchasing psychology						
	6. Defi	ne innovative revenue models						
Module I	Introdu	ction to Business Models			9 H	ours		
Facebook,	Customer	ness Model Generation, Business Model Canvas, Examp s, Value Proposition, Sales & Delivery Channels, Custo Activities, Partners						
Module		ction to Designing Innovative Business Models, Produ	ct and D	Design	9 H	ours		
II	Innovat							
		Examples; AirBnb model, Better Product, Success storie n, Tesla Innovation Model	s of Tin	der and	l Uber	– Case		
Module III	-	er Innovation: Customer niches, Sales & Delivery Cha	nnels,		9 H	ours		
Disrupting		Relationships, Acquire first time customer, Disrupting C	Customer	segme	ents, Fo	ocus on		
		niche, Disrupt delivery Channels, Digital Sales channel						
Module IV	Resourc	e Driven Innovation			6 H	ours		
New produ companies	ct develoj	oment strategies, Innovative production techniques, Auto	mation o	of smal	l and r	nedium		
Module V	Revenue	Model Innovation & Purchasing Psychology			12 Hours			
Disrupting		nodels, Subscription models, Freemium and Micro payme cople Buy – Necessity, Loss Aversion, Fear, Convenience						
				TOTA	L: 45 I	HOURS		
 Elaborate Conduct 	Key Conc the Desig user interv Design Dr READIN		fy opport	unities				
	 HBR's 10 Must Reads on Business Model Innovation (with featured article "Reinventin Your Business Model" by Mark W. Johnson, Clayton M. Christensen, and Henning Kagermann) (English, Paperback, Review Harvard Business) The Business Model Book (Adam J. Bock, Gerard George) The Field guide to Human Centered Design by IDEO.org 							
REFEREN	CES:							
1.The Busin April 24, 20		l Innovation Factory: How to Stay Relevant When The World Saplan	d is Char	iging H	ardcov	er –		
	y Design:	How Design Thinking Transforms Organizations and Inspire	s Innovat	tion				
3. The busir Frankenberg	ness model ger, and M	navigator is a book that comes out from the research of Oliv lichaela Csik.			Carolin			
		neration: A Handbook for Visionaries, Gameby Alexande yday ThingsBook by Don Norman, 1988	r Osterwa	alder				

6. Testing Business Ideas: A Field Guide for Rapid Experimentation (Strategyzer) 1st Edition by David J. Bland (Author), Alexander Osterwalder 7. https://nptel.ac.in/courses/109104109/

OPEN ELECTIVE-II

1903EC017		EMBEDDED SYSTEMS	L	Τ	P	С
		(Open Elective)	3	0	0	3
<u> </u>						
Course Obj						
		Discuss the concepts of basic embedded systems.				
		Describe about the ARM architecture.	11 1			
		To introduce various technologies and protocols involved in Embe ocols.	dded	com	imuni	cation
		To study about the different I/O device interfacing modules.				
		To use the embedded controllers in real time applications.				
	5. 1	to use the embedded contronors in real time approactions.				
Unit I	Introduc	tion			(9 Hours
		ed System, Embedded System Architecture, Embedded hardward	e En	bed		
		dded Systems and Characteristics, Challenges and Design issues				
Embedded S						5-2221115
Unit II	ARM Pr					9 Hours
ARM proces	ssor naming	g, Types. CISC vs. RISC, Von-Neumann vs. Harvard architect	ture.	ARM	M M3	;
		bipeline, Mode of operation, Instruction set, Exception handling	,		_	
Unit III	-	ed Communication Protocols			(9 Hours
Communicat	tion protoco	ols - USART, I2C, CAN, SPI. Wireless communication protocol	s: Bl	ueto	oth, Z	ZigBee,
Z wave.	I	, , , , , , , , , , , , , , , , , , ,			. ,	0
Unit IV	I/O Devi	ce Interfacing			9	Hours
C Programm		acing Simple I/O Devices Like LED, Seven Segment, LCD, S	Switc	hes.	Mot	or (DC.
		and Sensors. Introduction to IOT		,		
Unit V		ed controllers Application			9	9 Hours
Home autom	nation, Wire	eless sensor monitoring, Environmental monitoring, Gas leakage d	letect	ion,	Eleva	tor
		ng timers, Washing machine, Auto focusing Digital camera and W				
		Total:			4	5Hours
Further Rea	ading:					
	1. Arduin	10				
	2. Machin	ne learning using raspberry pi				
Course Out	comes:					
		npletion of the course, Student will be able to				
	1. 0	utline the properties of embedded system.				
		pint out the functionality of ARM processor				
		lake use of the communication protocols in application specific pu	irpos	es		
		terface I/O device peripherals with microcontroller				
	5. Sc	olve the real life problems using embedded systems				
References:						
		bedded Systems- Architecture, Programming and Design", Secon	d Edi	tion,	Tata	
McC		ublications, 2008.				
	Sanchez Ma	aria P.Canton, "Microcontroller Programming: The microchip PIC	C", C	RC F	ress,	
2. Julio S						
2. Julio S Tayl	lor & Franci	is Group, 2007.				
2. Julio S Tayl 3. The 80	lor & Franci 051 Microc	ontroller and Embedded Systems Using Assembly and C Second	Editi	on N	Iuhan	nmad
2. Julio S Tayl 3. The 80 Ali N	lor & Franci 051 Microc Mazidi Janio	ontroller and Embedded Systems Using Assembly and C Second ce GillispieMazidiRolin D. McKinlay				
2. Julio S Tayl 3. The 80 Ali M 4. Marti	lor & Franci 051 Microc Mazidi Janio	ontroller and Embedded Systems Using Assembly and C Second ce GillispieMazidiRolin D. McKinlay nterfacing PIC microcontrollers-Embedded Design by Interactive				

B.E. Electronics and Communication Engineering | E.G.S. Pillay Engineering College (Autonomous) | Regulations2019 Approved in IV Academic Council Meeting held on 25-05-2019

1903EC007		AUTOMOTIVE ELECTRONICS	L	Т	Р	С
		(Open Elective)	3	0	0	3
Course Objectives						
		o describe on Automotive Sensors, Actuators and Instr		tions		
	2. T	o articulate functions of various systems in automobile	es.			
Unit I	VEIIICI	E SYSTEMS			9 Hour	
		em, Fuel System (Carburettor Diesel Fuel Injection)	Ignitic			
		stems (Cooling, Lubrications & Electrical Systems)),	, ignin	лзу	stem, E	Mausi
Unit II		E AUXILLARY SYSTEMS			9 Hour	s
		Rear &4 wheels Drive, Manual, Automatic Transmission	on, Diff			
•		c, Pneumatic), Steering System (Rack and Pinion, Pov				U
Unit III	ELECTR	ONIC CONTROL		(9 Hour	s
		Control, Electronic Ignition Control, Integrated Eng		ntrol	System	, Anti-
locking Braking Sy	stem, Elect	ronic Suspension System, Electronic Steering Control				
Unit IV	SENSOR	S AND INDICATORS		(9 Hour	s
		ion, Display Devices, Flat Panel Display, Fuel Quan	tity Mea	asurer	nent, C	oolant
Temperature Measu	urement, Oi	l Pressure Measurement, Speed Measurement,				
Unit V	COMMU	INICATION AND NAVIGATION		9	9 Hour	s
• • •		cation (CAN BUS), Telematics, GPS Navigation, GI	PS Syste	em St	ructure,	,
Automotive Diagno	ostics.					
Eunthan Dooding.		E-Vehicles, Hybrid trains.	'otal:		45	Hours
Further Reading: Course Outcomes		E-venicies, Hybrid trains.				
Course Outcomes.		pletion of the course, Student will be able to				
		escribe various vehicle systems in an automobile				
		ustrate different types of auxiliary system in an automotion	obile			
		itline the various electronic control systems				
		emonstrate various sensor and measurement technique	s			
		amine various communication and navigation techniq				
References:						
1. Joerg Schae	uffele, Tho	mas Zurawka, —Automotive Software Engineering F	rinciple	es, Pro	ocesses,	,
		AE International, 2005.				
		andbook, 6th Edition, 2014.				
		Understanding Automotive Electronics- An Engineerin Ieinemann Publications, 2012.	g Presp	ective	e",7th	
		s, "Automotive Electrical Equipment", ELBS & New				
5. Tom Weath New Jersey		nd c. Ilunter, "Automotive computers and control syste	em", Pre	entice	Hall In	с.,
6. Crouse W.H	., "Automo	oile Electrical Equipment", Mc Graw Hill Co. Inc., N ding Automotive Electronic", SAE,1998	ew Yor	k ,199	95. 5.	

1903EC026		MOBILE COMMUNICATION	L	Т	Р	С		
		(Open Elective)	3	0	0	3		
	-							
Course Objective	s:							
		p impart the fundamentals concepts of wireless communication						
		communication.						
		o understand the concepts of signalling schemes for fading characteristic concepts of signalling characteris	nnels	and	analyz	ze its		
Unit I	INTRODU	UCTION TO WIRELESS MOBILE COMMUNICATION		9) Hou	rs		
History and evolut	ion of mobil	e radio systems, Types of mobile wireless services/systems -	Cell	ular, `	WLL,	Paging,		
		ture trends in personal wireless systems				0 0		
Unit II	CELLULA	AR MOBILE WIRELESS SYSTEMS			9 Hou	rs		
Cellular Systems:	Structure - C	Cell Cluster - Frequency reuse - Channel Interference - Cell s	splitt	ing a	nd sec	ctoring -		
		Fixed, Dynamic and Hybrid - Network Architecture - Mobility	y					
		gement - Resource Management: Microcell Concept.			_			
Unit III		ND SYSTEMS			9 Hou			
		- GPRS: Network Architecture, Signaling, Mobility n						
		IA: IS95 systems, Forward link, Reverse Link, PN sequence	ce re	lated	to C	DMA -		
UMTS: Network A								
Unit IV		IG PRINCIPLE OF CELL PHONE			9 Hou			
		ll phone work, Cell phone network, Cell phone call travel, Se	etting	g up a	ı call	process,		
-		Invention of mobile.						
Unit V		TECHNOLOGY			9 Hou	rs		
GSM.3G, 4G (LTH	E), NFC syste	ems, WLAN technology. WLL. Hyper LAN. Ad hoc networks		etoot				
		Tota	al:		4	5 Hours		
Further Reading:								
		ommunication						
	2. FSOC							
Course Outcomes								
	5:							
	After comp	pletion of the course, Student will be able to						
	After comp 6. De	pletion of the course, Student will be able to escribe the concept of cellular and wireless mobile communica						
	After comp 6. De 7. De	pletion of the course, Student will be able to escribe the concept of cellular and wireless mobile communica esign Base Station (BS) parameters and analyze the antenna co			ns.			
	After comp 6. De 7. De	pletion of the course, Student will be able to escribe the concept of cellular and wireless mobile communica			ns.			
	After comp 6. De 7. De 8. Ex 9. Su	pletion of the course, Student will be able to escribe the concept of cellular and wireless mobile communica esign Base Station (BS) parameters and analyze the antenna co xplain the various concept of Wideband systems. Immarize the working principles of cell phone			ns.			
	After comp 6. De 7. De 8. Ex 9. Su	pletion of the course, Student will be able to escribe the concept of cellular and wireless mobile communica esign Base Station (BS) parameters and analyze the antenna co xplain the various concept of Wideband systems.			ns.			
References:	After comp 6. De 7. De 8. Ex 9. Su 10. As	pletion of the course, Student will be able to escribe the concept of cellular and wireless mobile communica esign Base Station (BS) parameters and analyze the antenna co xplain the various concept of Wideband systems. Immarize the working principles of cell phone ssess the latest wireless technologies.	onfigu	uratio				
1. Cory Bear	After comp 6. De 7. De 8. Ex 9. Su 10. As	pletion of the course, Student will be able to escribe the concept of cellular and wireless mobile communica esign Base Station (BS) parameters and analyze the antenna co splain the various concept of Wideband systems. Immarize the working principles of cell phone ssess the latest wireless technologies.	onfigu	uratio		<u>.</u>		
1.Cory Bear2.A.F.Molis	After comp 6. De 7. De 8. Ex 9. Su 10. As rd and Willia sch, Wireless	pletion of the course, Student will be able to escribe the concept of cellular and wireless mobile communica esign Base Station (BS) parameters and analyze the antenna co xplain the various concept of Wideband systems. Immarize the working principles of cell phone ssess the latest wireless technologies. Im Stallings, "Wireless Communication Networks and Systems of Communications, Wiley, 2005.	onfigu s" Pe	arson	, 2015			
1.Cory Bear2.A.F.Molis3.T.S.Rappa	After comp 6. De 7. De 8. Ex 9. Su 10. As d and Willia sch, Wireless aport, Wirele	pletion of the course, Student will be able to escribe the concept of cellular and wireless mobile communica esign Base Station (BS) parameters and analyze the antenna co splain the various concept of Wideband systems. Immarize the working principles of cell phone ssess the latest wireless technologies.	onfigu s" Pe	arson	, 2015			
1.Cory Bear2.A.F.Molis3.T.S.RappaPrentice H	After comp 6. De 7. De 8. Ex 9. Su 10. As rd and Willia sch, Wireless aport, Wirele fall of India,	pletion of the course, Student will be able to escribe the concept of cellular and wireless mobile communica esign Base Station (BS) parameters and analyze the antenna co xplain the various concept of Wideband systems. Immarize the working principles of cell phone ssess the latest wireless technologies. Im Stallings, "Wireless Communication Networks and Systems communications, Wiley, 2005. ess Communications: Principles and Practice, Second Edition, F Third Indian Reprint 2003.	onfigu s" Pe Pears	arson arson E	, 2015 ducati	on /		
1.Cory Bear2.A.F.Molis3.T.S.Rappa Prentice F4.ITI SahaM	After comp 6. De 7. De 8. Ex 9. Su 10. As rd and Willia sch, Wireless aport, Wirele fall of India,	pletion of the course, Student will be able to escribe the concept of cellular and wireless mobile communica esign Base Station (BS) parameters and analyze the antenna co xplain the various concept of Wideband systems. Immarize the working principles of cell phone ssess the latest wireless technologies. Im Stallings, "Wireless Communication Networks and Systems a Communications, Wiley, 2005. Ess Communications: Principles and Practice, Second Edition, F Third Indian Reprint 2003. ess Communication and Networks : 3G and beyond", McGraw	onfigu s" Pe Pears	arson arson E	, 2015 ducati	on/		
1. Cory Bear 2. A.F.Molis 3. T.S.Rappa Prentice F 4. ITI SahaM Ltd., Second	After comp 6. De 7. De 8. Ex 9. Su 10. As rd and Willia sch, Wireless aport, Wirele fall of India, fisra, "Wirele ond edition, 2	pletion of the course, Student will be able to escribe the concept of cellular and wireless mobile communica esign Base Station (BS) parameters and analyze the antenna co xplain the various concept of Wideband systems. Immarize the working principles of cell phone ssess the latest wireless technologies. Im Stallings, "Wireless Communication Networks and Systems a Communications, Wiley, 2005. Ess Communications: Principles and Practice, Second Edition, F Third Indian Reprint 2003. ess Communication and Networks : 3G and beyond", McGraw	onfigu s" Pears Pears v Hill	arson arson E	, 2015 ducati	on / Pvt.		
1.Cory Bear2.A.F.Molis3.T.S.Rappa Prentice H4.ITI SahaM Ltd., Seco5.K. Daniel	After comp 6. De 7. De 8. Ex 9. Su 10. As rd and Willia sch, Wireless aport, Wirele fall of India, fisra, "Wirele and edition, 2 Wong, "Fun	pletion of the course, Student will be able to escribe the concept of cellular and wireless mobile communica esign Base Station (BS) parameters and analyze the antenna co xplain the various concept of Wideband systems. Immarize the working principles of cell phone ssess the latest wireless technologies. Im Stallings, "Wireless Communication Networks and Systems communications, Wiley, 2005. Ess Communications: Principles and Practice, Second Edition, I Third Indian Reprint 2003. ess Communication and Networks : 3G and beyond", McGraw 2013.	onfigu s" Pears Pears v Hill	arson arson E	, 2015 ducati	on / Pvt.		

1903EC004		DISPLAY SYSTEMS]	L	Т	Р	С
				3	0	0	3
<u> </u>							
Course Objectives							
		expose the students to the basics of the display system	ns and to	o illu	istrate	e the c	current
	de	sign practices of the display systems.					
Unit I	Introducti	on to Display systems			9) Hou	rs
Introduction to dis		rements of displays. Display technologies, CRT, Fl	at panel	an	d adv	anced	l display
technologies. Tech			1				1 5
Unit II	Head Mou	nted Display) Hou	
		ys less than and greater than 0.5 m diagonal. Low pow	er and li	ight			
Unit III		Deration of Display			9) Hou	rs
		LCDs, Brightness. Types of LCD displays.					
Unit IV	Types of D) Hou	
		asma display and Field emission displays, operating p	orinciple	and			
Unit V		ns of Display			9) Hou	rs
Types of Displays:	3D, HDTV,	LED, Touch screen.					
			Total	:			45 Hours
Further Reading:							
		Communication					
	2. FSOC						
Course Outcomes							
		letion of the course, Student will be able to preciate the technical requirement of different types of	Edianlary		atoma		
		alyze the various low power lighting systems	uispiays	s sy	stems		
		derstand the operation of TFTs and LCD displays.					
		alyze the various kinds of emissive displays					
		tically evaluate the recent advancements in the display	s device	e tec	hnolo	ogv.	
References:						0,	
1. L.W. Macl	konald& A.C	2. Lowe, Display Systems, Design and Applications, V	Wiley, 20	003.			
		nnesholtz, Projection Displays, Wiley, 1999					
3. Peter A. K	Keller, Electro	onic Display Measurement: Concepts, Techniques, and	l Instrum	nenta	ation,	Wile	y-Inter
science, 19	997.						
Recent lite	erature in Dis	play Systems.					

1903EC027		ANALOG AND DIGTIAL COMMUNICATION	L	Т	Р	С
	-		3	0	0	3
Course Objective	s:					
_	1. To	introduce the concepts of various modulations and their spec	etral c	harac	teristi	cs.
	2. To	learn Pulse modulation techniques.				
	3. To	understand the various Band pass signaling schemes and	sprea	d spe	ctrum	1
	teo	chniques.	-	-		
	·					
Unit I		JDE MODULATION			Hou	
		n systems – Modulation – Need for modulation – Class				
		ation – Generation and Detection of AM – Transmitters and				
		Side Band Suppressed Carrier (DSBSC) systems - generatio				
	systems – SS	B-SC generation and detection, Vestigial Side Band (VSB)	- Co	mparı	son o	t various
AM systems.		ADDII ATION) TT .	
Unit II		10DULATION	ъл ·		Hou	
		band and wideband FM – Generation of FM signal: Direct F				
		sing detectors – FM transmitters – FM receivers – Phase Mo	dulati	lon -	Phase	Locked
Loop – Compariso Unit III		ODULATION TECHNIQUES) Hou	
		-	1	-		
		parison of Pulse modulation – Sampling of Band limited				
		Quantization – Companding - Pulse Code Modulation –			-	lse code
		n – Adaptive Delta modulation – Intersymbol Interference	-Ey	-		
Unit IV		D DATA TRANSMISSION TECHNIQUES			9 Hou	
		ntation of signal, Signal constellation diagram, Error probabi PSK, MSK, GMSK and QAM coherent schemes – Comparis				
Unit V	SYNCHR	ONIZATION AND SPREAD SPECTRUM TECHNIQ	UES	9) Hou	rs
Importance of Syn	chronization	- Carrier, frame and symbol/Chip synchronization technique	es, Sp	oread 3	Spect	um- PN
		- Direct Sequence and Frequency Hopping Spread Spectru	um Sy	ystem	s –Pro	ocessing
gain and Jamming	Margin – M	Iltiple access techniques TDMA – FDMA – CDMA				
		Tot	al:		4	5 Hours
Further Reading:						
		sign of AM and FM radio, Television Receivers.				
		obile radio propagation.				
Course Outcomes	1					
		letion of the course, Student will be able to				
	1. Ex	amine the spectrum and methods of generation and detection	of A	M sys	tems	and its
		Des.				
		evelop the mathematical model for time domain representation	n, spe	ectrum	and	nethods
		and detection of angle modulation systems.				
		ly the concepts of sampling process and determine the character	ristics	of Pu	lse Mo	odulation
	schemes.	1		1		
		lyze the performance of different digital modulation /demodulat			ues	
	<u>з. Ар</u> р	ly the knowledge on the principle of spread spectrum and synch	ITOHIZ	ation.		
1. Simon Ha	ykin "Comr	nunication Systems" John Wiley & Sons, 4th Edition-2016.				
		Communications" McGraw Hill, 5th edition -2007				
		cation Systems" BS Publication-2004. log communication", Oxford University press-2010				
		Communication", 2nd Edition, Pearson Education, 2006.				
		.ac.in/courses/117/105/117105143/				
-	<u> </u>	ecourses.nptel.ac.in/noc20_ee17/course				
7. INPLEMENT	. mups.//onini	10001365.11pte1.ac.111/110020_0017/000186				

PROFESSIONAL ELECTIVES – III

1903EC011	MICROELECTRONICS	L	Т	Р	С		
		3	0	0	3		
Course Objective	S:						
	1. To be exposed of basics of semiconductor and applications.						
	2. To be familiar with advanced semiconductors and its applicat	ions.					
	3. To study the different types of amplifiers and its types.						
	4. To know about fabrication methodologies and circuit designing	ng.					
Unit I	INTRODUCTION TO MICROELECTRONICS:			9 Hou			
	miconductor-diode models and circuits-physics of MOS transistor-MOS a						
	nductor theory- diodes -bipolar junction transistor(BJT)-BJT amplifiers-f	ïeld e	ffect	transi	stor –		
FET amplifiers.							
Unit II	MOSFET AND IC AMPLIFIERS:		9	9 Hou	irs		
Devices structure a	nd physical operation-VI characteristics-biasing in MOS amplifier circuit	s-sma	ll sig	nal op	veration		
	E MOSFET-IC design philosophy-comparison of MOSFET and BJT-curre						
mirrors-current ste	ering circuits-high frequency response.						
Unit III	MULTI STAGE AMPLIFIER AND FEEDBACK:			9 Hov	irs		
	pair –small signal operation of MOS differential pair-BJT differential pair						
	differential pair-differential amplifier with active words-multistage ampli						
	c feedback topologies-series, shunt feedback-determining the loop gain- sta	ability	v prob	lems-	effect		
	plifiers poles-frequency compensation.						
Unit IV	MICROELECTRONICS FABRICATION:			9 Hou			
	logy-silicon wafer production-thermal oxidation -lithography -advanced						
	nd ion implementation-thin film deposition –packaging –yields processing	g-CM	OS &	BIP	JLAR		
	in practice-photo lithography-CVD epitaxy-plasma etching.) TT .			
Unit V	MICROELECTRONIC DEVICES AND CIRCUITS:			9 Hou			
	n semiconductor equilibrium-Uniform excitation of semiconductors- Non						
	Five basic equations-Non uniform Carrier Injection :Flow Problems –Non uniformly Doped Semiconductors- Junction Diodes-Bipolar Junction Transistors-The MOS capacitor-Field effect Transistors-Single Transistor Linear						
	Differential Amplifiers Stages-High Frequency Analysis of Linear Amplif		Trans	SISTOL	Linear		
Ampimers Stags-L	Since the analysis of Linear Ampin	leis.					
	Tot	al:		4	5 Hours		
Further Reading:							
	1. Commercial applications of Microelectronic circuits.						
	2. Finfet						
Course Outcomes							
	After completion of the course, Student will be able to						
	1.Explain the theory, principle of semiconductors and its devices.						
	2.Learn the characteristics of advanced semiconductors and its applic						
	3. Discuss the working principle and characteristics of different types	of an	nplifi	ers.			

	4. Explain the fabrication methodology of microelectronics components and devices					
	5. Explain the various characteristics of microelectronics devices and circuits					
References:	es:					
1.Microelctronics	y Claudio talarico, A.S. Sedra and K.C. Smith, microlctrcircuits, 5/e, oxford university press.					
2.Introduction to microelectronic fabrication by prof.glenn chapman.						
3.Microelectronic	levices and circuts 2006 electronic edition by clitonG.Fonsand.					
4.Fundamentals of	microelectronics, Behzadrazavi ,johnwileyindia pvt,ltd,2008.					
5.Microelectronic	– analysis and design, sundaram Natarajan. Tata McGraw hill.2007					

1903EC012		ROBOTICS	L	Т	Р	С					
190020012			3	0	0	3					
Course Objectives	s:		-	-	,	-					
		o demonstrate the concepts behind robots									
		o interpret the electronics applications in robot for various pu	rpose								
Unit I	INTRODUCTION 9 Hours										
		rigin of robotics, Purpose of Robots, Artificial Intelligence, F									
-	ot characteri	stics – accuracy, precision, and repeatability, classification o	f robo	ots, so	cial is	sues of					
robotics.											
Unit II		C DRIVE SYSTEMS				9 Hours					
		ators: Hydraulic, Pneumatic and Electric drives. Specificatio									
		pper motor, Servo motor and brushless DC motor, Micropro	cessoi	conti	ol of	electric					
motors, speed cont	rol using PW	M and direction control using H- Bridge									
Unit III	SENSORS					9 Hours					
		ors, Strain gauge based forcetorque sensors, Tachometers, To	uch a	nd Pr							
		s, Bend sensors, Pressure sensor, Smell, Humidity, Testing se		ina i i	coourt	,					
T lezoeleetite mater	liui, o witchie	s, Dena sensors, riessare sensor, sinen, riamany, resting s									
Unit IV	POWER A	AND NAVIGATION				9 Hours					
Photovoltaic Cells,	Fuel Cells,	Li ion Batteries									
Vision, Voice com	nunication, I	Route planning, Adaptive control, Error monitoring and recov	ery,A	utono	my ar	nd					
	ots, Automat	ed Guided Vehicles	-		-						
Unit V	CASE STU	UDIES				9 Hours					
		applications of Robots in material handling and assemblySpe	ech-c	ontro	lled n	nobile					
robot, Medical rob	ots, Underwa	ater bots, Aerobots, Drones And Robotic arm									
		Tot	al:		4	5 Hours					
Further Reading:											
		umanoid robots									
		nematics, Inverse Kinematics, Jacobians									
Course Outcomes											
	After comp	bletion of the course, Student will be able to									
	1. Articulate the concepts behind robots										
	2. Outline the concepts of drive systems in robots										
3. Summarize the sensors used in robots with its purpose											
4. Examine various power sources for robot											
	5. Inspect various techniques related to navigation of robot.										
	6. Elabor	rate the applications of the robots									
References:											
 Mikell and Groover, Industrial Robotics – Technology, Programming and Applications, McGraw Hill, 2/e, 2012 											
2. Saeed B. N	Niku Introdu	ction to Robotics. Analysis and control, applications- Wiley s	studer	t edit	ion, 2	010					
	l Vidyasagar	, Robot Dynamics and Control, John Wiley & Sons, 1990.									
		ENTALS of ROBOT TECHNOLOGY" Springer Netherland otics, Fundamental concepts and analysis, OXFORD Univers									

1903EC013		NETWORK SECURITY	L	Т	Р	С				
			3	0	0	3				
Course Objectives	s:									
	1. To gain knowledge on the various attacks in a network									
	2. To acquire knowledge on various encryption standards.									
3. To build the ability to develop security standard based on the requirement										
						0.77				
Unit I	INTRODU		•	<u> </u>		8 Hours				
		ks, Security Services, Mechanisms- Model for Network Security								
Modes-ECB-CBC-		utions-Transpositions Techniques- Stream Cipher, Block Ci	pner-i	SIOCK	Cipn	er				
Unit II		IPHERS AND THE DATA ENCRYPTION STANDARD)			8 Hours				
		nalysis- DES-Modes of operation-Triple DES-AES-RC4 –R			0 110 11 5					
Unit III		GORITHM, KEY MANAGEMENT				9 Hours				
Hash Function-Me		t algorithm (MD 5)- Secure Hash Algorithm- Diffie-Helln	nan K	lev E						
		Distribution- Key Agreement - Elliptic Curve Cryptograp								
Authentication Pro			2	U	C					
Unit IV	SECURIT	Y PRACTICE & SYSTEM SECURITY				9 Hours				
Authentication app	lications – K	erberos - X.509 Authentication services - Internet Firewalls	for T	rustee	l Syst	em:				
		lated terminology- Types of Firewalls - Firewall designs - S								
		on detection system - Virus and related threats - Countermea	sures	– Fire	ewalls	s design				
		Practical implementation of cryptography and security.								
Unit V		P & WEB SECURITY				1 Hours				
E-mail Security: Security Services for E-mail-attacks possible through E-mail - establishing keys privacy-										
		-Message Integrity-Non-repudiation-Pretty Good Privacy								
		IPv6-Authentication Header-Encapsulation Security Pay KMP/IKE Encoding). Web Security: SSL/TLS Basic Protection								
U		ployed by SSL Attacks fixed in v3- Exportability-Encoding		-	•	-				
Transaction (SET).		proyed by 552 radies fixed in v5 Exportability Electring	beeu		cuon					
Total: 45 Hour										
Further Reading:										
0		tacks- Primarily test- factoring, Discrete Logarithms								
	2. M	alicious software-viruses-Firewalls- Security Standards.								
Course Outcomes										
After completion of the course, Student will be able to										
	1. Identify vulnerability of computer networks to security threats.									
2. Acquire knowledge on existing security algorithms and cryptography standards.										
3. Understand various cryptography techniques and their implications on network security										
4. Analyze the type of security threat and the appropriate security standard to be adopted										
References:	5. Fo	ormulate and implement new security standards								
	tallings "Cm	ptography and Network Security: Principles and Practice", Pr	ontio	Hall	Drofo	acional				
		ourth Edition. 2004	entice		PIOLE	ssionai				
		1 C.VanOorSchot, Scott A.Van Stone, "Handbook Of Applie	d Crv	ntogr	anhv"	CRC				
Press, 199		re. vanooiseno, seou n. van stone, mandoook of rippie	u er j	progr	apity	, ene				
3. Atul Kahate "Cryptography and Network Security". Tata McGraw-Hill										
5. Wiley, John & Sons, Incorporated, October 1995.										
6. Richard E. Smith, "Internet Cryptography", Addison- Wesley, 1997										

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Course Objec		T		· . ,	.1		<u> </u>		• 1			1	<u> </u>			
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						es of p										
Unit I	NEURAI						Jytho	ni ian	guage						9	Hours
Need of Softe				-		ns Ne	etwor	rks –	Artif	icial	Neura	al Ne	etwork	s - S		
.unsupervised networks – Ra Neural Networ	learning - F adial Basis	Rein	force	ment	t Lea	rning	- A0	ctivat	ion fui	nctior	ns - Pe	ercep	tron -	Back	Propa	gation
Unit II	FUZZY I	LOO	GIC												9	Hours
Fuzzy Sets -															y Rule	es and
Fuzzy Reasonin							zy Ex	pert S	System	s – Fi	uzzy D	Decisi	on Ma	king.		
Unit III	GENETI	-		-												Hours
Genetic algorit	nstraints - cl	lassi	sificati	ion -	gene	etic pro	ograr									
Unit IV	INTROD				-	-			-						-	Hours
Why Python? - Indenting as R - Booleans - N	equirement umbers - Li	t - Ez ists -	xcepti -Array	ions - ys-Tı	- Unl uples	bound s - Sets	l Vari s - Di	iables iction	- Case aries –	e Sens	sitive	– Sci	ripts- Ì		Data '	Types
Unit V	PROGRA	AM	(MIN)	G CC	ONC	CEPTS	S IN	PYT	HON						9	Hours
Conditions-Lo Functions - Pa																face.
							_				Tota	l:			45	Hours
Further Read	ing:															
	Machine	lear	ming													
Course Outco																
	After com															
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References:)	5. I	Discu	ISS Va	ariou	is con	cepts	S OI (OPS	in Py	tnon					
1. J.S.R.	Jang, C.T. S ation 2004.	Sun	and E	E.Miz	utan	i, "Ne	euro-l	Fuzzy	and S	oft C	ompu	ting"	, PHI	Pear	son	
	Pilgrim, —]	Div	e into	Pvth	10n 3	SI. Apr	ress.	2009								
3. S.Raja	asekaran and ithm: Synth	d G.	.A.Vi	jayal	laksh	miPai	i, "Ne	eural	Netwo					Genet	ic	
4. David	E. Goldber	rg, "	'Gene											arnin	g" Pea	rson
5. Georg	ge J. Klir, Ut	te St		ir, Bo	o Yu	an, "F	uzzy	v Set T	heory	: Fou	ndatio	ns ar	nd App	olicati	ons"	
E-References	ce Hall, 199 •	91.														
	<mark>://cse.iitkgp</mark>	<mark>p.ac.</mark>	<mark>.in/~d</mark>	lsama	<mark>anta</mark>	<mark>/cour</mark> s	<mark>ses/a</mark>	rchiv	e/sca/	Slide	<mark>s.htm</mark>					
2. https:/	//docs.pytho	on.o	org													
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1903EC015		ADVANCED DIGITAL SIGNAL PROCESSING	L	Т	Р	С					
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Course Objectives	Course Objectives:										
	1. To explore the concepts of multi rate signal processing and multi rate filters.										
	2. To study the adaptive filters and its applications.										
	3. To know about Linear and Prediction concepts.										
	4. To le	arn fundamental concepts on signal processing in power spectro	um est	imati	on.						
Unit I	Multirate I	Digital signal Processing			91	Hours					
		nal Reconstruction-Sampling rate conversion – Decimation	oy an	integ							
interpolation by an	n integer facto	or –Sampling rate conversion by a rational factor – poly-phase	FIR	struct	ures -	- FIR					
		pefficients - Sampling rate conversion by a rational factor-	Multis	tage	desig	n of					
decimator and inter					0.1	T					
Unit II		TIR Filter Design	n in a	ional		Hours					
		ng rate conversion – Applications of Interpolation and decimation wo channel filter banks-QMF filter banks – Perfect Reconstruction									
structured filter bar	nks - DFT filt	er Banks – M-channel filter banks-octave filter banks			anks	uce					
Unit III		mation and Prediction			9 I	Hours					
		backward predictions, Solutions of the Normal equations- L									
algorithms. Least Wiener IIR filters,		d error criterion -Wiener filter for filtering and prediction, I	FIR W	liene	filte	r and					
Unit IV		daptive filters			91	Hours					
	0	steepest descent method – Adaptive filters based on steepest de	scent	nethc							
		S based adaptive filters- RLS, Exponentially weighted RLS - Sli									
		nel equalization, noise cancellation, prediction.	U								
Unit V	Power Spec	etral Estimation			9 I	Hours					
Estimation of spec	tra from finite	duration observations of a signal –The Periodogram-Use of DI	-T in F	ower	spect	ral					
		thods for Power spectrum Estimation – Bartlett. Welch and Bla									
		mance of Non – Parametric power spectrum Estimation method									
		auto correlation and model parameters, Yule-Walker equations	s, solu	tions	using						
Durbin's algorithm	1,AR, MA, AI	RMA model based spectral estimation.		20	. 151	T					
Further Reading:		Το	al:	30	+ 15 1	Iours					
Further Keaunig:		as of adaptive filters: Adaptive channel equalization Adaptive	tivo o	cho /	anco	llor					
	Adaptive n	oise cancellation-, 1/M-octave-band filter banks, Speech en	hance	nent	using						
	spectrum es				6						
Course Outcomes											
		etion of the course, Student will be able to									
1. Design and implement decimator and interpolator and to design multi rate filter bank and											
acquires knowledge of how a multi rate system work											
 Understand different spectral estimation techniques and linear prediction Explain about LMS and RLS adaptive filters for signal enhancement, channel equation 											
 Explain about EMS and KES adaptive Inters for signal enhancement, channel equation Illustrate different Power spectrum methods and solutions 											
References:	4. musura	the different Power spectrum methods and solutions									
	on Haves St	atistical Digital Signal Processing and Modeling, John V	Viley	and	Sone	Inc					
2008.	лі Пауся, э	austical Digital Signal Processing and Wootening, John V	wney	anu	50115,	me.,					
2. G. John Proakis and G. Dimitris Manolakis, Digital Signal Processin g, Pearson Education, 2006.											
3. P.P.Vaidyanathan, Multirate Systems and Filter Banks, Pearson Education, 2008.											
4. N.J.Filege, Multirate Digital Signal Processing, John Wiley and Sons, 2000.											
 O.DiRinaki and Govithous Roy, Statistical asignal Approcessing and processing structure of a WPHill, 2002. 											
6. Sophonel	es J. Orfanidi	is, Optimum Signal Processing , McGraw Hill, 2007.									